



P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI

Product Summary

V _{(BR)DSS}	R _{DS(ON)}	I _D T _A = +25°C
-30V	$7.5 \text{m}\Omega$ @ $V_{GS} = -10V$	-36A
-30 V	$10m\Omega$ @ $V_{GS} = -4.5V$	-31A

Description

This new generation 30V P-Channel Enhancement Mode MOSFET is designed to minimize $R_{DS(ON)}$, yet maintain superior switching performance. This device is ideal for use in notebook battery power management and loadswitch.

Applications

- Notebook Battery Power Management
- DC-DC Converters
- Loadswitch

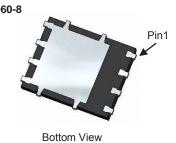
Features

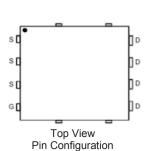
- Thermally Efficient Package Cooler Running Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- <1.1mm Package Profile Ideal for Thin Applications
- ESD HBM Protected up to 1kV
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Available (Note 4)

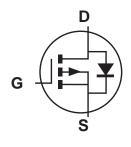
Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish 100% Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.097 grams (Approximate)









Internal Schematic

Ordering Information (Note 5)

Part Number	Qualification	Case	Packaging
DMP3010LPSQ-13	Automotive	PowerDI5060-8	2,500/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/quality/product_compliance_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



Marking Information



☐ = Manufacturer's Marking P3010LS = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 15 = 2015) WW = Week (01 - 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristi	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	-30	V		
Gate-Source Voltage			V_{GSS}	±20	V
Continuous Drain Current (Note 8) V _{GS} = 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-36 -29	А
Continuous Drain Current (Note 8) V _{GS} = 4.5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-31 -25	А
Continuous Drain Current (Note 7) V _{GS} = 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-14.5 -11.5	А
Pulsed Drain Current (Notes 7 & 10)			I _{DM}	-100	А
Avalanche Current (Notes 11 & 12)			I _{AS}	-17.5	Α
Avalanche Energy (Notes 11 & 12) L = 1mH			E _{AS}	153	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	1.26	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 6)	RθJA	97	°C/W
Power Dissipation (Note 7)	P_{D}	2.18	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 7)	R _{θJA}	55	°C/W
Power Dissipation (Note 8)	P_D	14.37	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 8)	R _{θJA}	8.7	°C/W
Power Dissipation (Notes 8 & 9)	P_D	58.7	W
Thermal Resistance, Junction to Case @T _C = +25°C (Notes 8 & 9)	$R_{ heta JC}$	2.13	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes:

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 8. Device mounted on FR-4 PCB with infinite heatsink.
- 9. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.
- 10. Repetitive rating, pulse width limited by junction temperature, 10µs pulse, duty cycle = 1%.
- 11. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep T_J = +25°C.



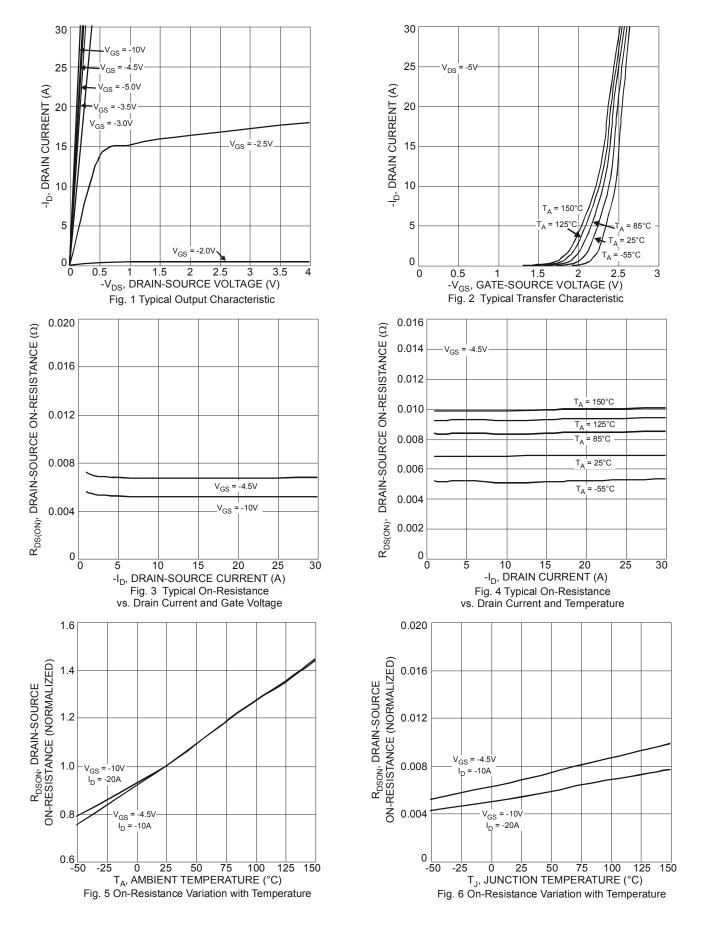
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 12)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	1	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1	μΑ	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 12)							
Gate Threshold Voltage	$V_{GS(th)}$	-1.1	-1.6	-2.1	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance		l	5.7	7.5	mΩ	$V_{GS} = -10V, I_D = -10A$	
Static Diain-Source On-Nesistance	R _{DS(ON)}	_	7.2	10	11122	$V_{GS} = -4.5V, I_D = -10A$	
Forward Transfer Admittance	Y _{fs}	_	30	_	S	$V_{DS} = -15V, I_{D} = -10A$	
Diode Forward Voltage	V_{SD}	_	-0.65	-1	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 13)	•						
Input Capacitance	Ciss		6,234		pF	15 / 15 / 1/	
Output Capacitance	Coss	_	1,500		pF	V _{DS} = 15V, V _{GS} = 0V, -f = 1MHz	
Reverse Transfer Capacitance	C _{rss}	_	774	_	pF	1 - 1101112	
Gate Resistance	Rg	_	1.28	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = -10V)	Qg	_	126.2	_	nC	V _{DS} = -15V, I _D = -10A	
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	59.2	_	nC	45)()(
Gate-Source Charge	Q _{gs}	_	16.1	_	nC	$V_{DS} = -15V, V_{GS} = -4.5V,$	
Gate-Drain Charge	Q _{gd}	_	15.7	_	nC	I _D = -10A	
Turn-On Delay Time	t _{D(on)}	_	11.4	_	ns		
Turn-On Rise Time	t _r	_	9.4	_	ns	$V_{DS} = -15V, V_{GEN} = -10V,$	
Turn-Off Delay Time	t _{D(off)}	_	260.7	_	ns	$R_G = 6\Omega$, $I_D = -1A$	
Turn-Off Fall Time	t _f	_	99.3	_	ns		

Notes:

^{12.} Short duration pulse test used to minimize self-heating effect. 13. Guaranteed by design. Not subject to product testing.







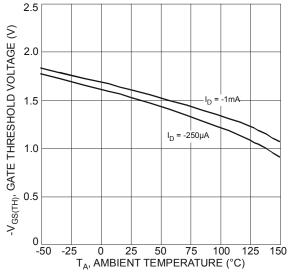
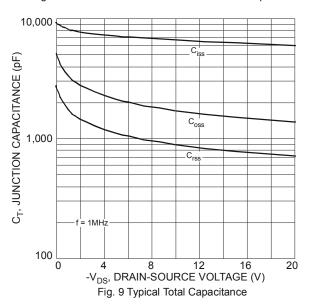
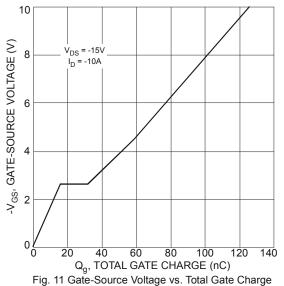


Fig. 7 Gate Threshold Variation vs. Ambient Temperature





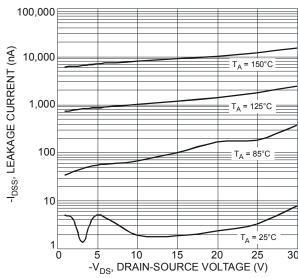
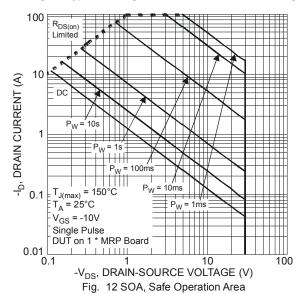
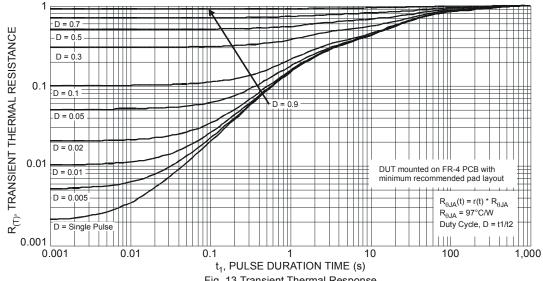


Fig. 10 Typical Leakage Current vs. Drain-Source Voltage





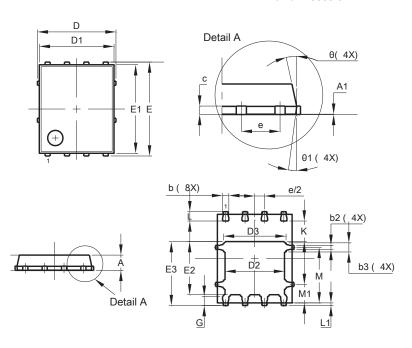




Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

PowerDI5060-8

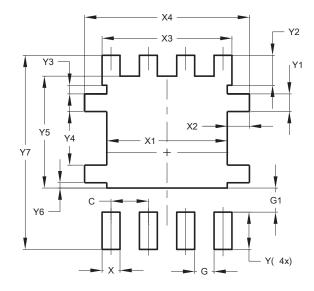


PowerDI5060-8					
Dim	Min Max Ty				
Α	0.90	1.10	1.00		
A1	0.00	0.05	_		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D		5.15 BSC			
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	3.90 4.30 4.10			
Е	(6.15 BSC	;		
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
M	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Χ	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Υ	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610



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